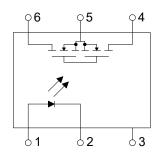
KAQV212 Series

6PIN 60V N.O TYPE SOLID STATE RELAY-MOSFET OUTPUT

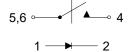
Description

The KAQV212 series is robust, ideal for telecom and ground fault applications. It is a SPST normally open switch (1 Form A) that replaces electromechanical relays in many applications. It is constructed using a GaAlAs LED for actuation control and an integrated monolithic die for the switch output. The die, fabricated in a high-voltage dielectrically isolated technology, is comprised of a photodiode array, switch control circuitry and MOSFET switches.

Schematic



1 FORM A NORMALLY OPEN



Features

- 1. Normally open, single pole single throw
- 2. Control 60V AC or DC voltage
- 3. Switch 400mA loads
- 4. Controls low-level analog signals
- 5. High sensitivity, low ON resistance
- 6. Low-level off-state leakage current
- 7. High isolation voltage 5KV (DIP / SMD)
- 8. Pb free and RoHS compliant
- 9. MSL class 1
- 10. Agency Approvals:
 - UL Approved (No. E108430): UL508
 - c-UL Approved (No. E108430)
 - FIMKO Approved: EN62368-1, EN60601-1
 - VDE Approved (No. 40053989): EN60747-5-5

Application

- Telecommunications (PC, electronic notepad)
- Modem
- Telephone equipment
- Security equipment
- Sensors
- Measuring and testing equipment
- Factory automation equipment
- High speed inspection machines

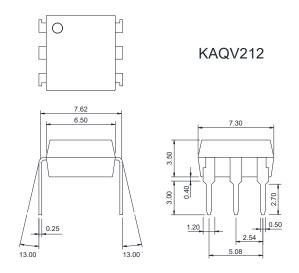


Unit: mm

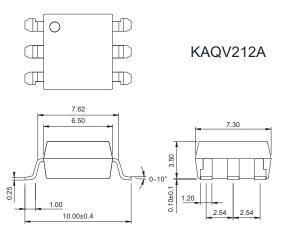
6PIN 60V N.O TYPE SOLID STATE RELAY-MOSFET OUTPUT

Outside Dimension

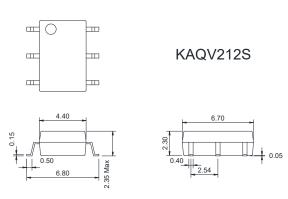
1. Dual-in-line type.



2. Surface mount type.

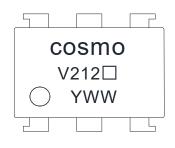


3. Small outline for surface mount type.



TOLERANCE: ±0.2mm

Device Marking





Notes:

cosmo

V212 ☐ (Blank): DIP or SMD

V212S S: SOP

YWW Y: Year code / W: Week code



KAQV212 Series

6PIN 60V N.O TYPE SOLID STATE RELAY-MOSFET OUTPUT

Absolute Maximum Ratings

(Ta=25°℃)

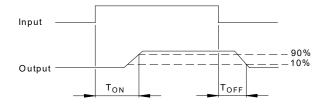
Parameter		Symbol	Rating	Unit
	Continuous forward current	I _F	50	mA
Input	Peak forward current	I _{FP}	1	Α
	Reverse voltage	V_R	5	V
	Power dissipation	P _{in}	100	mW
	Derate linearly from 25℃	-	1.3m	mW/°C
	Breakdown voltage	V _B	60	V
Output	Continuous load current	Ι _L	400	mA
	Power dissipation	P _{out}	500	mW
laalatias	Isolation voltage		KAQV212S	KAQV212
isolation			1500Vrms	5000Vrms
Isolation resistance (Vio=500V)		R _{iso}	$\ge 10^{10}$	Ω
Total power dissipation		Pt	550	mW
Derate linearly from 25°C		-	2.5m	mW/°C
Operating temperature		T _{opr}	-40 to +85	$^{\circ}\!\mathbb{C}$
Storage temperature		T _{stg}	-40 to +125	$^{\circ}\!\mathbb{C}$
Junction temperature		Tj	100	$^{\circ}\!\mathbb{C}$
Soldering temperature 10 seconds		T _{sot}	260	$^{\circ}\! \mathbb{C}$

• Electro-optical Characteristics

(Ta=25°ℂ)

Parameter			Symbol	Conditions	Min.	Тур.	Max.	Unit	
	Forward voltage		V _F	I _F =10mA	-	1.2	1.5	V	
Input	Operation input current			I _{FON}	V _L =20V, I _L =100mA	-	-	3.0	mA
	Recovery input current		I _{FOFF}	V_L =20V, I_L \leq 5 μ A	0.2	-	-	mA	
Output	Breakdown voltage			V_B	I _B =50μA	60	-	-	V
Output	Off-state leakage current			I _{LEAK}	V _L =60V, I _F =0mA	-	0.2	1.0	μΑ
I/O capacitance			C _{iso}	V _B =0V, f=1MHz	-	6	-	pF	
ON resistance			Α		I _F =10mA, I _L =100mA	-	0.83	2.50	
		connection	В	R _{ON}		-	0.44	1.25	Ω
			С			-	0.25	0.63	
Turn-on time			T _{ON}	I _F =10mA, V _L =20V	-	0.3	1.5	ms	
Turn-off time			T _{OFF}	I _L =100mA, t=10ms	-	0.1	1.5	ms	

• Turn-on / Turn-off Time





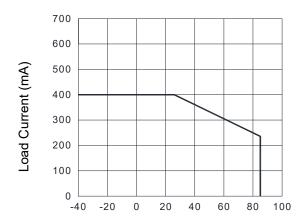
KAQV212 Series

6PIN 60V N.O TYPE SOLID STATE RELAY-MOSFET OUTPUT

• Schematic and Wiring Diagrams

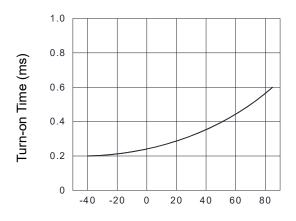
Schematic an Schematic	Output Configuration	Load	Connection	Wiring Diagrams
		AC DC	A	V _N T 1D 2
3 4 0	1a	DC	В	V _N T C _Q C _Q
	DC	DC	С	V _N Load V _t (DC) so Load V _t (DC)

Fig.1 Load Current vs. Ambient Temperature



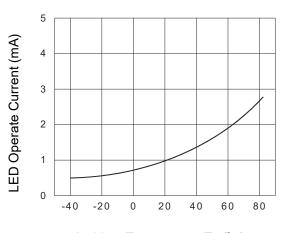
Ambient Temperature Ta (°C)

Fig.3 Turn-on Time vs. Ambient Temperature



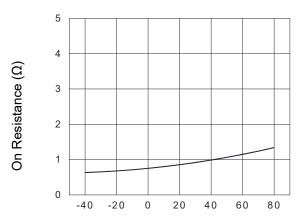
Ambient Temperature Ta (°C)

Fig.5 LED Operate Current vs. Ambient Temperature



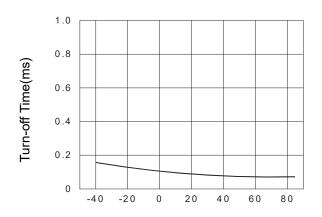
Ambient Temperature Ta (°C)

Fig.2 On Resistance vs. Ambient Temperature



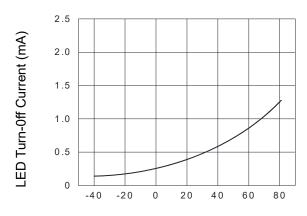
Ambient Temperature Ta (°C)

Fig.4 Turn-off Time vs. Ambient Temperature



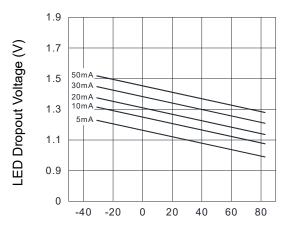
Ambient Temperature Ta (°C)

Fig.6 LED Turn-off Current vs. Ambient Temperature



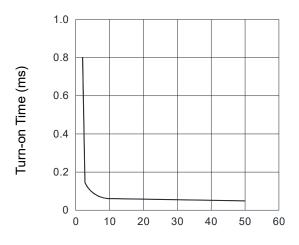
Ambient Temperature Ta (°C)

Fig.7 LED Dropout Voltage vs. Ambient Temperature



Ambient Temperature Ta (°C)

Fig.9 Turn-on Time vs. LED Forward Current



LED Forward Current (mA)

Fig.11 Turn-off Time vs. LED Forward Current

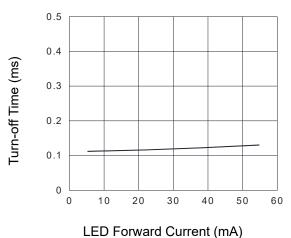
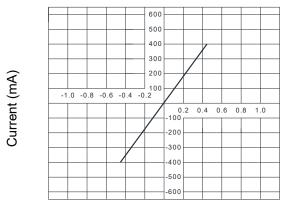


Fig.8 Voltage vs. Current Characteristics of Output at MOSFET Portion



Voltage (V)

Fig.10 Off-state Leakage Current vs. Load Voltage

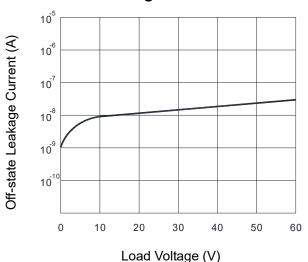
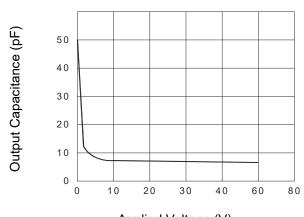


Fig.12 Output Capacitance vs. Applied Voltage

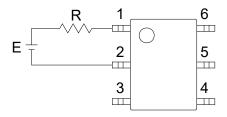


Applied Voltage (V)



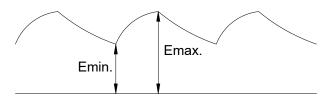
Using Methods

Examples of resistance value to control LED forward current (I_F=5mA)

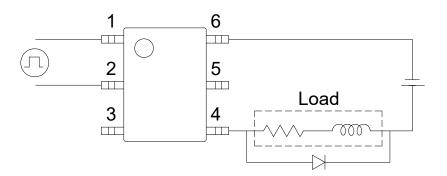


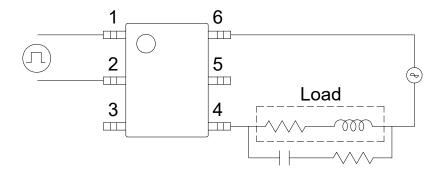
E	R		
3.3V	Approx. 330 Ω		
5V	Approx. 640 Ω		
12V	Approx. 1.9K Ω		
15V	Approx. 2.5K Ω		
24V	Approx. 4.1K Ω		

- 1. LED forward current must be more than 5mA, at E min.
- 2. LED forward current must be less than 50mA, at E max.



Regulate the spike voltage generated on the inductive load as follows:





R-C Snubber



KAQV212 Series 6PIN 60V N.O TYPE SOLID STATE RELAY-MOSFET OUTPUT

Recommended Soldering Conditions

(a) Infrared reflow soldering:

■ Peak reflow soldering : 260°C or below (package surface temperature)

■ Time of peak reflow temperature: 10 sec
 ■ Time of temperature higher than 230°C: 30-60 sec
 ■ Time to preheat temperature from 60-120 sec

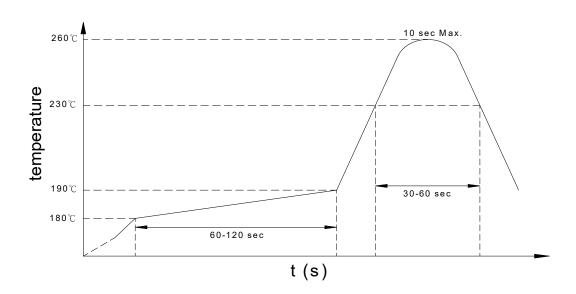
180~190°C : Two

Number of reflows : Rosin flux containing small amount of chlorine (The

■ Flux: flux with a maximum chlorine content of 0.2 Wt% is

recommended.)

Recommended Temperature Profile of Infrared Reflow



(b) Wave soldering:

■ Temperature : 260°C or below (molten solder temperature)

■ Time : 10 seconds or less

■ Preheating conditions:
120°C or below (package surface temperature)

■ Number of times : One

■ Flux : Rosin flux containing small amount of chlorine (The flux with a

maximum

chlorine content of 0.2 Wt% is recommended.)

(c) Cautions:

Fluxes: Avoid removing the residual flux with freon-based and

chlorine-based cleaning solvent.

Avoid shorting between portion of frame and leads.



Numbering System

KAQV212 X (Y)

Notes:

KAQV212 = Part No.

X = Lead form option (blank · S or A)

Y = Tape and reel option (TL · TR)

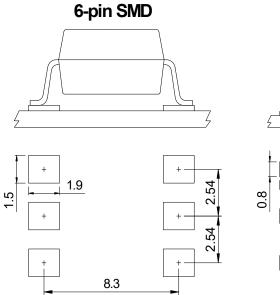
Option	Description	Packing quantity		
A (TL)	surface mount type package + TL tape & reel option	1000 units per reel		
A (TR)	surface mount type package + TR tape & reel option	1000 units per reel		
S (TL)	small outline for surface mount type package + TL tape & reel option	2000 units per reel		
S (TR)	small outline for surface mount type package + TR tape & reel option	2000 units per reel		

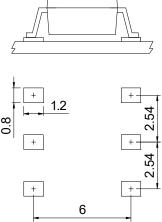
• Recommended Pad Layout for Surface Mount Lead Form

1. Surface mount type.

2. Small outline for surface mount type.

6-pin SOP

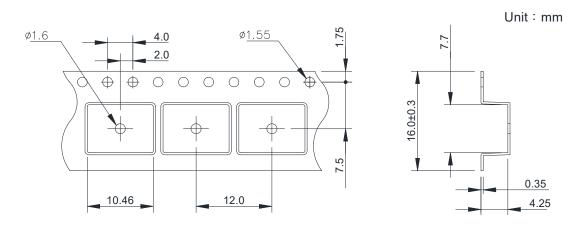




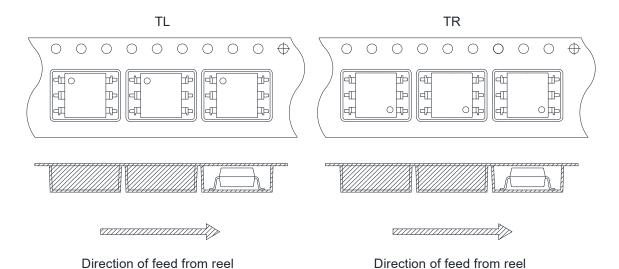
Unit: mm



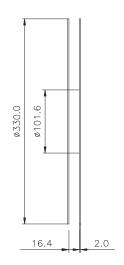
• 6-pin SMD Carrier Tape & Reel



TOLERANCE: ±0.2mm

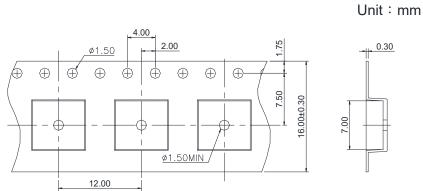


Ø13.0 1.5 Ø20.2

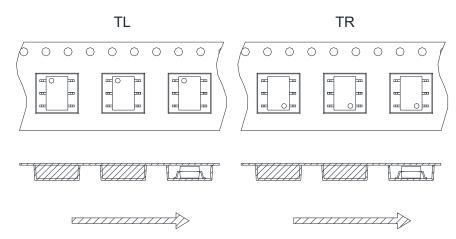


SOLID STATE RELAY-MOSFET OUTPUT

• 6-pin SOP Carrier Tape & Reel

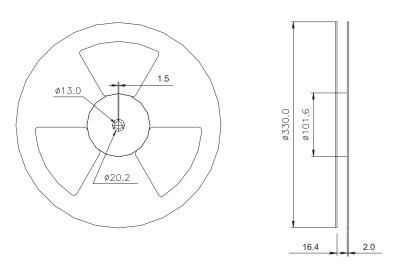


TOLERANCE: ±0.2mm



Direction of feed from reel

Direction of feed from reel





KAQV212 Series 6PIN 60V N.O TYPE SOLID STATE RELAY-MOSFET OUTPUT

Application Notice

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